

Atty. Dkt. No. QUANT1190-3 (028248-1010)
LDQ-1190-CIP3

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Dershem et al.

Title: THERMOSETTING RESIN
COMPOSITIONS CONTAINING
MALEIMIDE AND/OR VINYL
COMPOUNDS

Appl. No.: 10/084,389

Filing Date: 02/25/2002

Examiner: Not Yet Assigned

Art Unit: 1712

CERTIFICATE OF FACSIMILE TRANSMISSION
I hereby certify that this paper is being facsimile transmitted to the United States Patent and Trademark Office, Washington, D.C. on the date below.

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August 1, 2002
(Date of Deposit)

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SUPPLEMENTAL PRELIMINARY AMENDMENT GROUP 1700

Commissioner for Patents
Washington, D.C. 20231

OFFICIAL

Sir:

Preliminary to examination on the merits, kindly amend the application as follows:

IN THE SPECIFICATION:

Kindly delete page 1, lines 1-5 of the Specification and insert therefor after the

Title:

-- RELATED APPLICATIONS

This application is a continuation of U.S. Patent Application No. 09/580,026, filed May 26, 2000, which is a continuation-in-part of U.S. Patent Application No. 09/107,897, filed June 29, 1998, now U.S. Patent No. 6,187,886, which itself is a continuation-in-part of U.S. Patent Application No. 08/711,982, filed September 10, 1996 (now U.S. Patent No. 5,789,757); this application also claims the benefit of an earlier